

Part Number: L-934SB/1G3ID

Green
High Efficiency Red

Features

- Quad-level design, save board space.
- Different color combination available.
- Black case enhances contrast.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

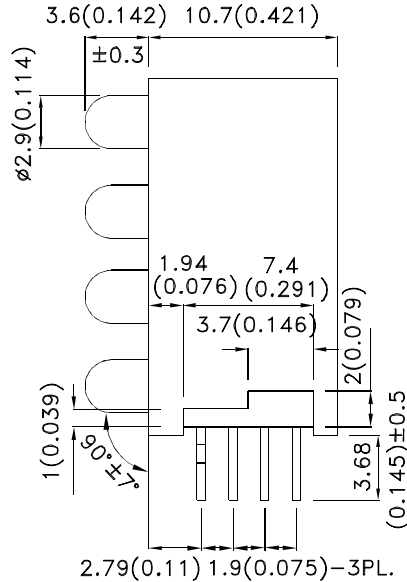
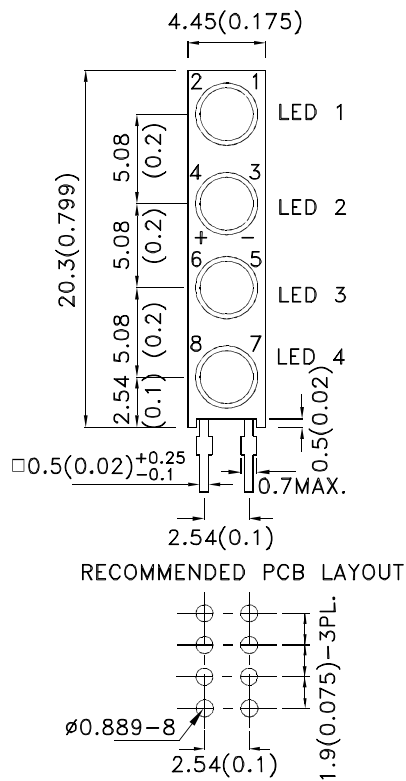
Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions

LED1: GREEN
LED2,3,4: RED



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 10mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
L-934SB/1G3ID	Green (GaP)	Green Diffused	10	25	40°
			*10	*25	
	High Efficiency Red (GaAsP/GaP)	Red Diffused	12	30	40°
			*10	*20	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ Luminous Flux: +/-15%.

* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green High Efficiency Red	565 627		nm	I _F =20mA
λD [1]	Dominant Wavelength	Green High Efficiency Red	568 617		nm	I _F =20mA
Δλ1/2	Spectral Line Half-width	Green High Efficiency Red	30 45		nm	I _F =20mA
C	Capacitance	Green High Efficiency Red	15 15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Green High Efficiency Red	2.2 2	2.5 2.5	V	I _F =20mA
I _R	Reverse Current	Green High Efficiency Red		10 10	uA	V _R = 5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

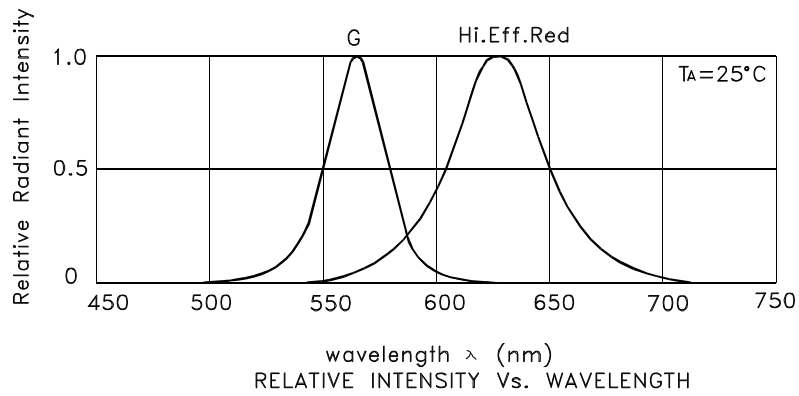
Parameter	Green	High Efficiency Red	Units
Power dissipation	62.5	75	mW
DC Forward Current	25	30	mA
Peak Forward Current [1]	140	160	mA
Reverse Voltage	5		V
Operating / Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

Notes:

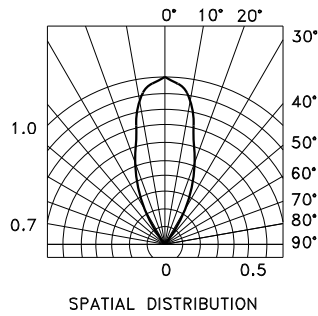
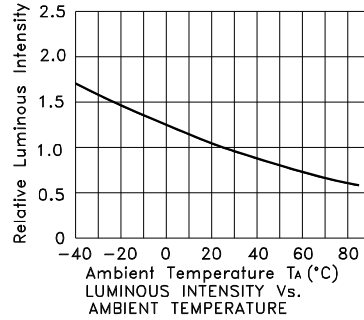
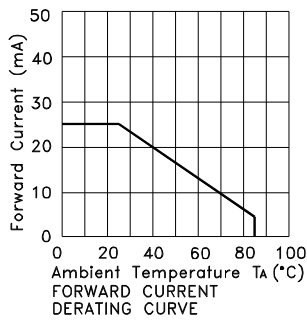
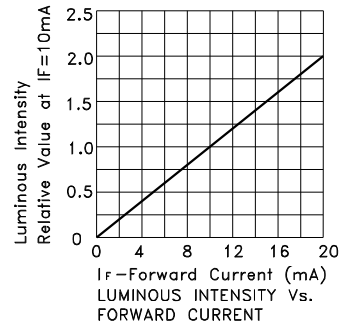
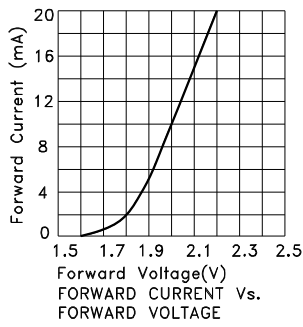
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

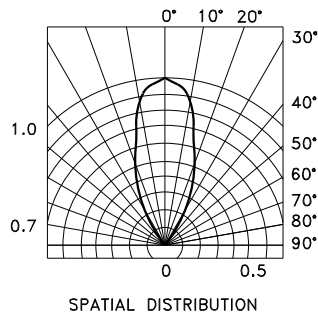
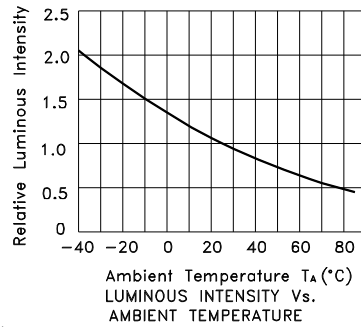
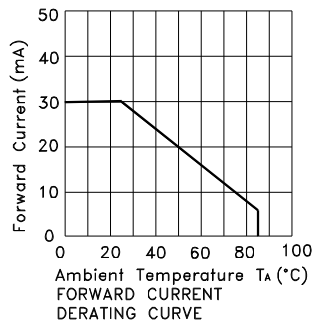
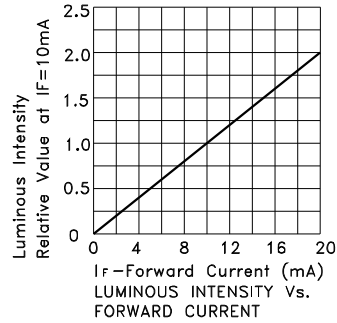
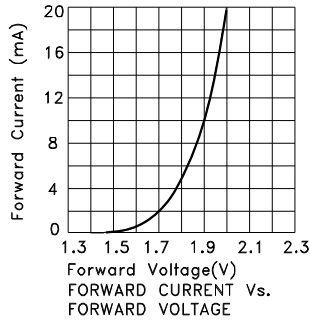
3. 5mm below package base.



L-934SB/1G3ID Green

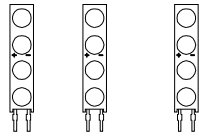


High Efficiency Red

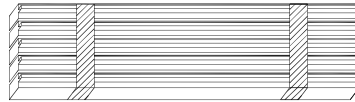


PACKING & LABEL SPECIFICATIONS

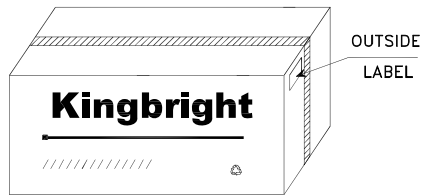
L-934SB/1G3ID



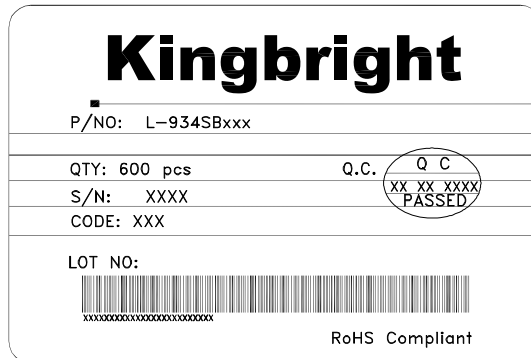
120PCS / IC TUBE



600pcs / 5pcs IC TUBE



8.4K / 6# BOX

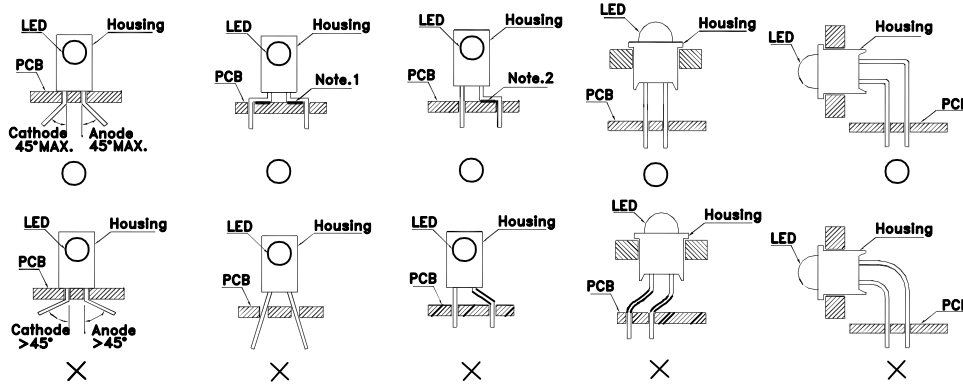


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PRECAUTIONS

- The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

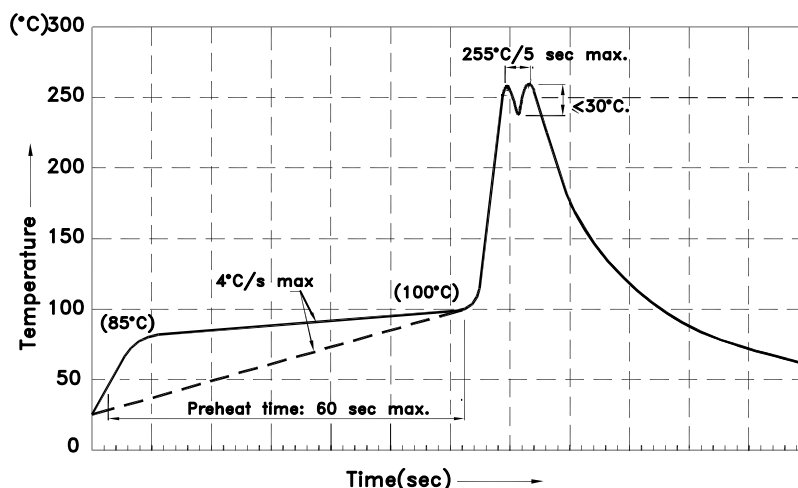


”○” Correct mounting method ”×” Incorrect mounting method

- During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- The tip of the soldering iron should never touch the lens epoxy.
- Through-hole LEDs are incompatible with reflow soldering.
- If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- Recommended Wave Soldering Profiles:



Notes:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- Do not apply stress to the epoxy resin while the temperature is above 85°C.
- Fixtures should not incur stress on the component when mounting and during soldering process.
- SAC 305 solder alloy is recommended.
- No more than one wave soldering pass.